16-bit dual supply translating transceiver with configurable voltage translation; 3-state

Rev. 2 — 14 January 2019

**Product data sheet** 

### 1. General description

The 74AVC16T245-Q100 is a 16-bit transceiver with bidirectional level voltage translation and 3-state outputs. The device can be used as two 8-bit transceivers or as a 16-bit transceiver. It has dual supplies ( $V_{CC(A)}$  and  $V_{CC(B)}$ ) for voltage translation and four 8-bit input-output ports (nAn and nBn). Each port has its own output enable (nOE) and send/receive (nDIR) input for direction control.  $V_{CC(A)}$  and  $V_{CC(B)}$  can be independently supplied with any voltage between 0.8 V and 3.6 V. This flexibility makes the device suitable for low voltage translation between any of the following voltages: 0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V. A HIGH on nDIR selects transmission from nAn to nBn while a LOW on nDIR selects transmission from nBn to nAn. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state

The device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either  $V_{CC(A)}$  or  $V_{CC(B)}$  are at GND level, both nAn and nBn are in the high-impedance OFF-state.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range:
  - V<sub>CC(A)</sub>: 0.8 V to 3.6 V
  - V<sub>CC(B)</sub>: 0.8 V to 3.6 V
- · Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 class 3B exceeds 8000 V
  - HBM JESD22-A114E class 3B exceeds 8000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Maximum data rates:
  - 380 Mbit/s (≥ 1.8 V to 3.3 V translation)
  - 200 Mbit/s (≥ 1.1 V to 3.3 V translation)
  - 200 Mbit/s (≥ 1.1 V to 2.5 V translation)
  - 200 Mbit/s (≥ 1.1 V to 1.8 V translation)
  - 150 Mbit/s (≥ 1.1 V to 1.5 V translation)
  - 100 Mbit/s ( $\geq$  1.1 V to 1.2 V translation)
- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- IOFF circuitry provides partial Power-down mode operation

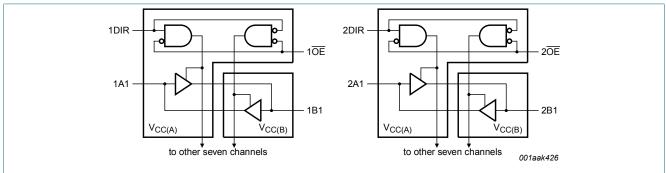
# ne<mark>x</mark>peria

### 3. Ordering information

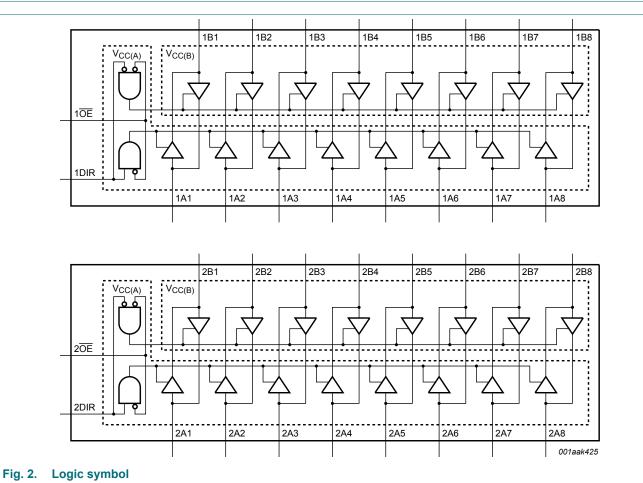
Table 1. Ordering information								
Type number	Package							
	Temperature range	Name	Description	Version				
74AVC16T245DGV-Q100	-40 °C to +125 °C		plastic thin shrink small outline package; 48 leads; body width 4.4 mm; lead pitch 0.4 mm	SOT480-1				

[1] Also known as TVSOP48.

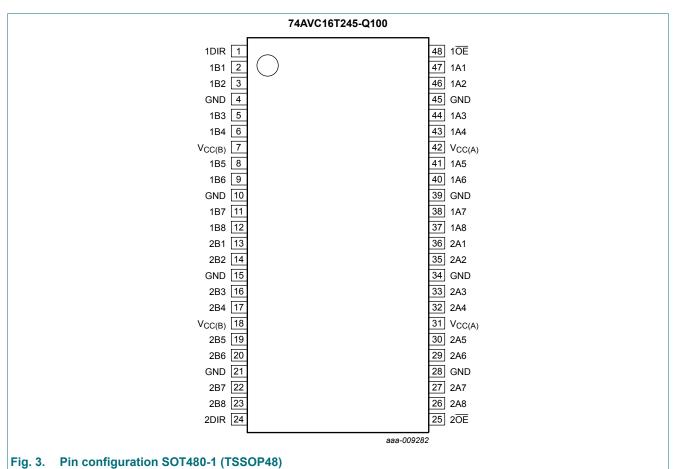
### 4. Functional diagram



#### Fig. 1. Logic diagram



### 5. Pinning information



#### 5.1. Pinning

#### 5.2. Pin description

#### Table 2. Pin description

Symbol	Pin	Description
1DIR, 2DIR	1, 24	direction control
1B1, 1B2, 1B3, 1B4, 1B5, 1B6, 1B7, 1B8	2, 3, 5, 6, 8, 9, 11, 12	data input or output
2B1, 2B2, 2B3, 2B4, 2B5, 2B6, 2B7, 2B8	13, 14, 16, 17, 19, 20, 22, 23	data input or output
GND [1]	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V <sub>CC(B)</sub>	7, 18	supply voltage B (nBn inputs are referenced to $V_{\text{CC}(\text{B})}$
10E, 20E	48, 25	output enable input (active LOW)
1A1, 1A2, 1A3, 1A4, 1A5, 1A6, 1A7, 1A8	47, 46, 44, 43, 41, 40, 38, 37	data input or output
2A1, 2A2, 2A3, 2A4, 2A5, 2A6, 2A7, 2A8	36, 35, 33, 32, 30, 29, 27, 26	data input or output
V <sub>CC(A)</sub>	31, 42	supply voltage A (nAn, n $\overline{\text{OE}}$ and nDIR inputs are referenced to $V_{\text{CC}(A)}$ )

[1] All GND pins must be connected to ground (0 V).

### 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Supply voltage	Input		Input/output [1]		
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	n <mark>OE [2]</mark>	nDIR [2]	nAn [2]	nBn [2]	
0.8 V to 3.6 V	L	L	nAn = nBn	input	
0.8 V to 3.6 V	L	Н	input	nBn = nAn	
0.8 V to 3.6 V	Н	Х	Z	Z	
GND [1]	Х	Х	Z	Z	

[1]

If at least one of  $V_{CC(A)}$  or  $V_{CC(B)}$  is at GND level, the device goes into suspend mode. The nAn, nDIR and nOE input circuit is referenced to  $V_{CC(A)}$ ; The nBn input circuit is referenced to  $V_{CC(B)}$ . [2]

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>CC(A)</sub>	supply voltage A			-0.5	+4.6	V
V <sub>CC(B)</sub>	supply voltage B			-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+4.6	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V		-50	-	mA
Vo	output voltage	Active mode [1][2	2][3]	-0.5	V <sub>CCO</sub> + 0.5	V
		Suspend or 3-state mode	[1]	-0.5	+4.6	V
I <sub>O</sub>	output current	$V_{O} = 0 V \text{ to } V_{CCO}$	[2]	-	±50	mA
I <sub>CC</sub>	supply current	per $V_{CC(A)}$ or $V_{CC(B)}$ pin		-	100	mA
I <sub>GND</sub>	ground current	per GND pin		-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C;	[4]	-	500	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

 $V_{\text{CCO}}$  is the supply voltage associated with the output port. [2]

[3] V<sub>CCO</sub> + 0.5 V should not exceed 4.6 V.

[4] Above 60 °C the value of  $\mathsf{P}_{tot}$  derates linearly with 5.5 mW/K.

### 8. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A			0.8	3.6	V
V <sub>CC(B)</sub>	supply voltage B			0.8	3.6	V
VI	input voltage			0	3.6	V
Vo	output voltage	Active mode	[1]	0	V <sub>CCO</sub>	V
		Suspend or 3-state mode		0	3.6	V
T <sub>amb</sub>	ambient temperature			-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CCI</sub> = 0.8 V to 3.6 V	[2]	-	5	ns/V

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2] V<sub>CCI</sub> is the supply voltage associated with the input port.

### 9. Static characteristics

#### Table 6. Typical static characteristics at T<sub>amb</sub> = 25 °C

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). [1]

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V <sub>OH</sub>	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	voltage	$I_{O}$ = -1.5 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 0.8 V		-	0.69	-	V
V <sub>OL</sub>	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	voltage	$I_{O}$ = 1.5 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 0.8 V		-	0.07	-	V
lı	input leakage current	nDIR, n $\overline{OE}$ input; V <sub>1</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	±0.025	±0.25	μA
I <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = V_{CC(B)} = 3.6 V$	[2]	-	±0.5	±2.5	μA
		suspend mode A port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = 3.6 V$ ; $V_{CC(B)} = 0 V$	[2]	-	±0.5	±2.5	μA
		suspend mode B port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = 0 V$ ; $V_{CC(B)} = 3.6 V$	[2]	-	±0.5	±2.5	μA
I <sub>OFF</sub>	power-off leakage current	A port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	±0.1	±1	μA
		B port; V <sub>1</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V		-	±0.1	±1	μA
CI	input capacitance	nDIR, n $\overline{OE}$ input; V <sub>1</sub> = 0 V or 3.3 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 3.3 V		-	2.0	-	pF
C <sub>I/O</sub>	input/output capacitance	A and B port; $V_0 = 3.3 \text{ V or } 0 \text{ V};$ $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$		-	4.5	-	pF

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2] For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). [1]

Symbol	Parameter	Conditions	-40 °C te	o +85 °C	-40 °C to	• +125 °C	Unit
			Min	Max	Min	Max	
VIH	HIGH-level	data input					
	input voltage	V <sub>CCI</sub> = 0.8 V	0.70V <sub>CCI</sub>	-	0.70V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	0.65V <sub>CCI</sub>	-	0.65V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	1.6	-	1.6	-	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	2	-	2	-	V
		nDIR, nOE input					
		V <sub>CC(A)</sub> = 0.8 V	0.70V <sub>CC(A)</sub>	-	0.70V <sub>CC(A)</sub>	-	V
		V <sub>CC(A)</sub> = 1.1 V to 1.95 V	0.65V <sub>CC(A)</sub>	-	0.65V <sub>CC(A)</sub>	-	V
		V <sub>CC(A)</sub> = 2.3 V to 2.7 V	1.6	-	1.6	-	V
		V <sub>CC(A)</sub> = 3.0 V to 3.6 V	2	-	2	-	V
V <sub>IL</sub>	LOW-level	data input					
	input voltage	V <sub>CCI</sub> = 0.8 V	-	0.30V <sub>CCI</sub>	-	0.30V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	-	0.35V <sub>CCI</sub>	-	0.35V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	-	0.7	-	0.7	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	-	0.8	-	0.8	V
		nDIR, nOE input					
		V <sub>CC(A)</sub> = 0.8 V	-	0.30V <sub>CC(A)</sub>	-	0.30V <sub>CC(A)</sub>	V
		V <sub>CC(A)</sub> = 1.1 V to 1.95 V	-	0.35V <sub>CC(A)</sub>	-	0.35V <sub>CC(A)</sub>	V
		V <sub>CC(A)</sub> = 2.3 V to 2.7 V	-	0.7	-	0.7	V
		V <sub>CC(A)</sub> = 3.0 V to 3.6 V	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	$I_{O}$ = -100 µA; $V_{CC(A)}$ = $V_{CC(B)}$ = 0.8 V to 3.6 V	V <sub>CCO</sub> - 0.1	-	V <sub>CCO</sub> - 0.1	-	V
		$I_{O}$ = -3 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 1.1 V	0.85	-	0.85	-	V
		$I_{O}$ = -6 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 1.4 V	1.05	-	1.05	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	1.2	-	1.2	-	V
		$I_{O}$ = -9 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 2.3 V	1.75	-	1.75	-	V
		$I_{O}$ = -12 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 3.0 V	2.3	-	2.3	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	$I_{O}$ = 100 µA; $V_{CC(A)} = V_{CC(B)}$ = 0.8 V to 3.6 V	-	0.1	-	0.1	V
		$I_{O}$ = 3 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 1.1 V	-	0.25	-	0.25	V
		$I_{O} = 6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	-	0.35	-	0.35	V
		I <sub>O</sub> = 8 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	-	0.45	-	0.45	V
		$I_{O}$ = 9 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 2.3 V	-	0.55	-	0.55	V
		$I_{O}$ = 12 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 3.0 V	-	0.7	-	0.7	V

Symbol	Parameter	Conditions		-40 °C t	o +85 °C	-40 °C to	o +125 ℃	Unit
			-	Min	Max	Min	Мах	
lı	input leakage current	nDIR, n $\overline{OE}$ input; V <sub>I</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	±1	-	±5	μA
I <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0$ V or $V_{CCO}$ ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V	[2]	-	±5	-	±30	μA
		suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 3.6 V;$ $V_{CC(B)} = 0 V$	[2]	-	±5	-	±30	μA
		suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 0 V;$ $V_{CC(B)} = 3.6 V$	[2]	-	±5	-	±30	μA
	power-off leakage current	A port; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	±5	-	±30	μA
		B port; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V		-	±5	-	±30	μA
I <sub>CC</sub>	supply current	A port; $V_I = 0 V$ or $V_{CCI}$ ; $I_O = 0 A$						
		V <sub>CC(A)</sub> = 0.8 V to 3.6 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	30	-	125	μA
		V <sub>CC(A)</sub> = 1.1 V to 3.6 V; V <sub>CC(B)</sub> = 1.1 V to 3.6 V		-	25	-	100	μA
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	25	-	100	μA
		V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 3.6 V		-5	-	-20	-	μA
		B port; $V_I = 0 V$ or $V_{CCI}$ ; $I_O = 0 A$						
		V <sub>CC(A)</sub> = 0.8 V to 3.6 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V		-	30	-	125	μA
		V <sub>CC(A)</sub> = 1.1 V to 3.6 V; V <sub>CC(B)</sub> = 1.1 V to 3.6 V		-	25	-	100	μA
		V <sub>CC(A)</sub> = 3.6 V; V <sub>CC(B)</sub> = 0 V		-5	-	-20	-	μA
		V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 3.6 V		-	25	-	100	μA
		A plus B port ( $I_{CC(A)} + I_{CC(B)}$ ); $I_{O} = 0$ A; $V_{I} = 0$ V or $V_{CCI}$ ; $V_{CC(A)} = 0.8$ V to 3.6 V; $V_{CC(B)} = 0.8$ V to 3.6 V		-	55	-	185	μA
		A plus B port ( $I_{CC(A)} + I_{CC(B)}$ ); $I_{O} = 0 A$ ; $V_{I} = 0 V \text{ or } V_{CCI}$ ; $V_{CC(A)} = 1.1 V \text{ to } 3.6 V$ ; $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$		-	45	-	150	μA

#### 16-bit dual supply translating transceiver with configurable voltage translation; 3-state

[1]  $V_{CCI}$  is the supply voltage associated with the data input port;  $V_{CCO}$  is the supply voltage associated with the output port. [2] For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

V <sub>CC(A)</sub>		V <sub>CC(B)</sub>									
	0 V	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V				
0 V	0	0.1	0.1	0.1	0.1	0.1	0.1	μA			
0.8 V	0.1	0.1	0.1	0.1	0.1	0.3	1.6	μA			
1.2 V	0.1	0.1	0.1	0.1	0.1	0.1	0.8	μA			
1.5 V	0.1	0.1	0.1	0.1	0.1	0.1	0.4	μA			
1.8 V	0.1	0.1	0.1	0.1	0.1	0.1	0.2	μA			
2.5 V	0.1	0.3	0.1	0.1	0.1	0.1	0.1	μA			
3.3 V	0.1	1.6	0.8	0.4	0.2	0.1	0.1	μA			

#### Table 8. Typicaltotal supply current (I<sub>CC(A)</sub> + I<sub>CC(B)</sub>)

### **10.** Dynamic characteristics

### Table 9. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C}$

Voltages are referenced to GND (ground = 0 V). [1][2]

Symbol	Parameter	Conditions			V <sub>CC(A)</sub> =	= V <sub>CC(B)</sub>			Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
C <sub>PD</sub> power dissipation	•	A port: (direction nAn to nBn); output enabled	0.2	0.2	0.2	0.2	0.3	0.4	pF
	dissipation capacitance	A port: (direction nAn to nBn); output disabled	0.2	0.2	0.2	0.2	0.3	0.4	pF
	capacitance	A port: (direction nBn to nAn); output enabled	9	9.7	9.8	10.3	11.7	13.7	pF
		A port: (direction nBn to nAn); output disabled	0.6	0.6	0.6	0.7	0.7	0.7	pF
		B port: (direction nAn to nBn); output enabled	9	9.7	9.8	10.3	11.7	13.7	pF
		B port: (direction nAn to nBn); output disabled	0.6	0.6	0.6	0.7	0.7	0.7	pF
		B port: (direction nBn to nAn); output enabled	0.2	0.2	0.2	0.2	0.3	0.4	pF
		B port: (direction nBn to nAn); output disabled	0.2	0.2	0.2	0.2	0.3	0.4	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:  $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

 $C_L$  = load capacitance in pF;  $V_{CC}$  = supply voltage in V;

N = number of inputs switching;  $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs.

[2]  $f_i = 10 \text{ MHz}$ ;  $V_I = \text{GND}$  to  $V_{CC}$ ;  $t_r = t_f = 1 \text{ ns}$ ;  $C_L = 0 \text{ pF}$ ;  $R_L = \infty \Omega$ .

#### Table 10. Typical dynamic characteristics at $V_{CC(A)}$ = 0.8 V and $T_{amb}$ = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6; for wave forms see Fig. 4 and Fig. 5. [1]

Symbol	Parameter	Conditions	V <sub>CC(B)</sub>						
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	propagation delay	nAn to nBn	14.4	7.0	6.2	6.0	5.9	6.0	ns
		nBn to nAn	14.4	12.4	12.1	11.9	11.8	11.8	ns
t <sub>dis</sub>	disable time	nOE to nAn	16.2	16.2	16.2	16.2	16.2	16.2	ns
		nOE to nBn	17.6	10.0	9.0	9.1	8.7	9.3	ns
t <sub>en</sub>	enable time	nOE to nAn	21.9	21.9	21.9	21.9	21.9	21.9	ns
		nOE to nBn	22.2	11.1	9.8	9.4	9.4	9.6	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}\text{;}$ 

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### Table 11. Typical dynamic characteristics at $V_{CC(B)}$ = 0.8 V and $T_{amb}$ = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6; for wave forms see Fig. 4 and Fig. 5. [1]

Symbol	Parameter	Conditions	V <sub>CC(A)</sub>						
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	propagation delay	nAn to nBn	14.4	12.4	12.1	11.9	11.8	11.8	ns
		nBn to nAn	14.4	7.0	6.2	6.0	5.9	6.0	ns
t <sub>dis</sub>	disable time	nOE to nAn	16.2	5.9	4.4	4.2	3.1	3.5	ns
		nOE to nBn	17.6	14.2	13.7	13.6	13.3	13.1	ns
t <sub>en</sub>		nOE to nAn	21.9	6.4	4.4	3.5	2.6	2.3	ns
		nOE to nBn	22.2	17.7	17.2	17.0	16.8	16.7	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;

 $t_{\text{en}}$  is the same as  $t_{\text{PZL}}$  and  $t_{\text{PZH}}.$ 

#### Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6; for wave forms see Fig. 4 and Fig. 5. [1]

Symbol	Parameter	Conditions				V <sub>CC(B)</sub>							Unit V
			1.2 V ± 0.1 V		1.5 V ± 0.1 V		1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		
			Min	Max	Min	Max	Min	Мах	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.1 V to 1.3 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.5	9.2	0.5	6.9	0.5	6.0	0.5	5.1	0.5	4.9	ns
	delay	nBn to nAn	0.5	9.2	0.5	8.7	0.5	8.5	0.5	8.2	0.5	8.0	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.5	11.6	1.5	11.6	1.5	11.6	1.5	11.6	1.5	11.6	ns
		n <del>OE</del> to nBn	1.5	12.5	1.5	9.7	1.5	9.5	1.0	8.1	1.0	8.9	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	1.0	14.5	1.0	14.5	1.0	14.5	1.0	14.5	1.0	14.5	ns
		n <del>OE</del> to nBn	1.1	14.9	1.1	11.0	1.1	9.6	1.0	8.1	1.0	7.7	ns
V <sub>CC(A)</sub> =	1.4 V to 1.6 V												·
t <sub>pd</sub>	propagation	nAn to nBn	0.5	8.7	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	ns
	delay	nBn to nAn	0.5	6.9	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	ns
		n <del>OE</del> to nBn	1.5	11.4	1.5	8.7	1.5	7.5	1.0	6.5	1.0	6.3	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	1.0	10.1	1.0	10.1	1.0	10.1	1.0	10.1	1.0	10.1	ns
		n <del>OE</del> to nBn	1.0	13.5	1.0	10.1	0.5	8.1	0.5	5.9	0.5	5.2	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95	V							<u> </u>				
t <sub>pd</sub>	propagation	nAn to nBn	0.5	8.5	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	ns
	delay	nBn to nAn	0.5	6.0	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	ns
		n <del>OE</del> to nBn	1.5	11.1	1.5	8.4	1.5	7.1	1.0	5.9	1.0	5.7	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	1.0	7.8	1.0	7.8	1.0	7.8	1.0	7.8	1.0	7.8	ns
		n <del>OE</del> to nBn	1.0	13.0	1.0	9.2	0.5	7.4	0.5	5.3	0.5	4.5	ns
V <sub>CC(A)</sub> =	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.5	8.2	0.5	5.6	0.5	4.6	0.5	3.3	0.5	2.8	ns
	delay	nBn to nAn	0.5	5.1	0.5	4.1	0.5	3.7	0.5	3.4	0.5	3.2	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.0	6.1	1.0	6.1	1.0	6.1	1.0	6.1	1.0	6.1	ns
		n <del>OE</del> to nBn	1.0	10.6	1.0	7.9	1.0	6.6	1.0	6.1	1.0	5.2	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	ns
		n <del>OE</del> to nBn	0.5	12.5	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	ns
V <sub>CC(A)</sub> =	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.5	8.0	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7	ns
	delay	nBn to nAn	0.5	4.9	0.5	3.7	0.5	3.3	0.5	2.9	0.5	2.7	ns
t <sub>dis</sub>	disable time	nOE to nAn	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	ns
		nOE to nBn	1.0	10.3	1.0	7.7	1.0	6.5	1.0	5.2	0.5	5.0	ns
t <sub>en</sub>	enable time	nOE to nAn	0.5	4.3	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4.0	ns
		nOE to nBn	0.5	12.4	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4.0	ns

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6; for wave forms see Fig. 4 and Fig. 5. [1]

Symbol	Parameter	Conditions					Vc	C(B)					Unit
			1.2 V ± 0.1 V		1.5 V ± 0.1 V		1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		1
			Min	Max	Min	Max	Min	Мах	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.1 V to 1.3 V		-	1			1					1	
t <sub>pd</sub>	propagation	nAn to nBn	0.5	10.2	0.5	7.6	0.5	6.6	0.5	5.7	0.5	5.4	ns
	delay	nBn to nAn	0.5	10.2	0.5	9.6	0.5	9.4	0.5	9.1	0.5	8.8	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.5	12.8	1.5	12.8	1.5	12.8	1.5	12.8	1.5	12.8	ns
		n <del>OE</del> to nBn	1.5	13.8	1.5	10.7	1.5	10.5	1.0	9.0	1.5	9.8	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	1.0	16.0	1.0	16.0	1.0	16.0	1.0	16.0	1.0	16.0	ns
		n <del>OE</del> to nBn	1.1	16.4	1.1	12.1	1.1	10.6	1.0	9.0	1.0	8.5	ns
V <sub>CC(A)</sub> =	1.4 V to 1.6 V											·	
t <sub>pd</sub>	propagation	nAn to nBn	0.5	9.6	0.5	6.9	0.5	5.8	0.5	4.6	0.5	4.1	ns
	delay	nBn to nAn	0.5	7.6	0.5	6.9	0.5	6.5	0.5	6.2	0.5	6.1	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.5	10.1	1.5	10.1	1.5	10.1	1.5	10.1	1.5	10.1	ns
		nOE to nBn	1.5	12.6	1.5	9.6	1.5	8.3	1.0	7.2	1.0	7.0	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	1.0	11.2	1.0	11.2	1.0	11.2	1.0	11.2	1.0	11.2	ns
		nOE to nBn	1.0	14.9	1.0	11.2	0.5	9.0	0.5	6.5	0.5	5.8	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95	V											
t <sub>pd</sub>	propagation delay	nAn to nBn	0.5	9.4	0.5	6.5	0.5	5.3	0.5	4.1	0.5	3.7	ns
		nBn to nAn	0.5	6.6	0.5	5.8	0.5	5.3	0.5	5.0	0.5	4.9	ns
t <sub>dis</sub>	disable time	nOE to nAn	1.5	8.5	1.5	8.5	1.5	8.5	1.5	8.5	1.5	8.5	ns
		nOE to nBn	1.5	12.3	1.5	9.3	1.5	7.9	1.0	6.5	1.0	6.3	ns
t <sub>en</sub>	enable time	nOE to nAn	1.0	8.6	1.0	8.6	1.0	8.6	1.0	8.6	1.0	8.6	ns
		nOE to nBn	1.0	14.3	1.0	10.2	0.5	8.2	0.5	5.9	0.5	5.0	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.5	9.1	0.5	6.2	0.5	5.1	0.5	3.7	0.5	3.1	ns
	delay	nBn to nAn	0.5	5.7	0.5	4.6	0.5	4.1	0.5	3.8	0.5	3.6	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	1.0	6.8	1.0	6.8	1.0	6.8	1.0	6.8	1.0	6.8	ns
		n <del>OE</del> to nBn	1.0	11.7	1.0	8.7	1.0	7.3	1.0	6.8	1.0	5.8	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	0.5	5.9	0.5	5.9	0.5	5.9	0.5	5.9	0.5	5.9	ns
		n <del>OE</del> to nBn	0.5	13.8	0.5	10.4	0.5	8.1	0.5	5.7	0.5	5.0	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	nAn to nBn	0.5	8.8	0.5	6.1	0.5	4.9	0.5	3.6	0.5	3.0	ns
	delay	nBn to nAn	0.5	5.4	0.5	4.1	0.5	3.7	0.5	3.2	0.5	3.0	ns
t <sub>dis</sub>	disable time	n <del>OE</del> to nAn	0.5	5.5	0.5	5.5	0.5	5.5	0.5	5.5	0.5	5.5	ns
		n <del>OE</del> to nBn	1.0	11.4	1.0	8.5	1.0	7.2	1.0	5.8	0.5	5.5	ns
t <sub>en</sub>	enable time	n <del>OE</del> to nAn	0.5	4.8	0.5	4.8	0.5	4.7	0.5	4.6	0.5	4.4	ns
		nOE to nBn	0.5	13.7	0.5	10.3	0.5	8.0	0.5	5.4	0.5	4.4	ns

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

#### 10.1. Waveforms and test circuit

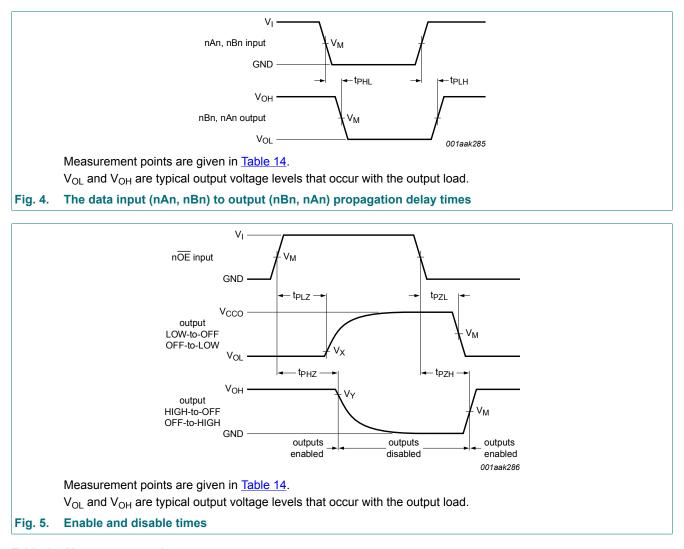
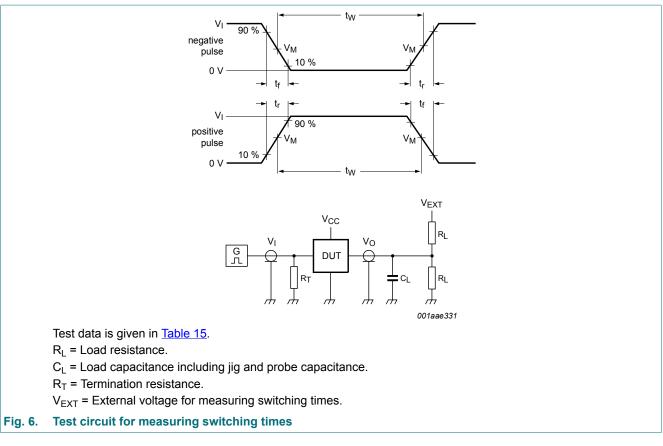


Table 14. Measurement points							
Supply voltage	Input [1]	Output [2]	Output [2]				
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
0.8 V to 1.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> - 0.1 V			
1.65 V to 2.7 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V			
3.0 V to 3.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V			

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

[2] V<sub>CCO</sub> is the supply voltage associated with the output port.

#### 16-bit dual supply translating transceiver with configurable voltage translation; 3-state



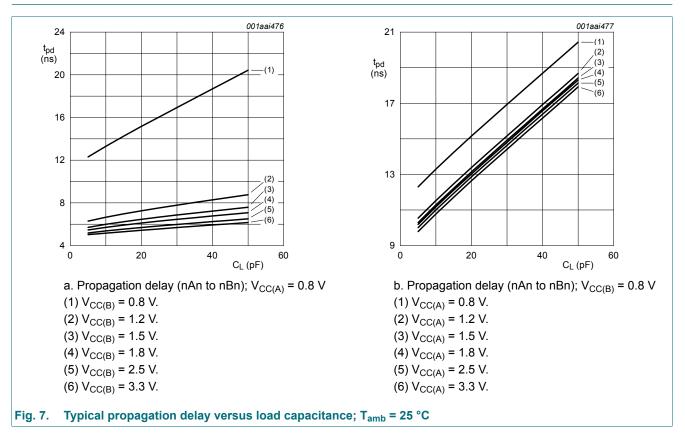
#### Table 15. Test data

Supply voltage Input			Load		V <sub>EXT</sub>		
$V_{CC(A)}, V_{CC(B)}$	V <sub>I</sub> [1]	Δt/ΔV [2]	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> [3]
0.8 V to 1.6 V	V <sub>CCI</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>
1.65 V to 2.7 V	V <sub>CCI</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>
3.0 V to 3.6 V	V <sub>CCI</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

[2] dV/dt ≥ 1.0 V/ns

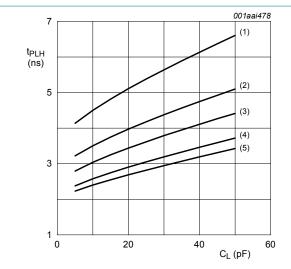
[3]  $V_{CCO}$  is the supply voltage associated with the output port.



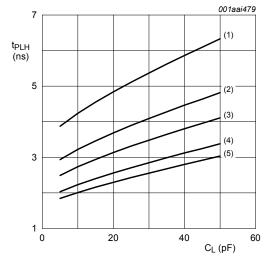
### 11. Typical propagation delay characteristics

001aai491

#### 16-bit dual supply translating transceiver with configurable voltage translation; 3-state

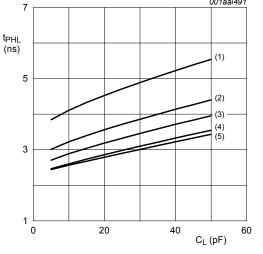


a. LOW to HIGH propagation delay (nAn to nBn); V<sub>CC(A)</sub> = 1.2 V

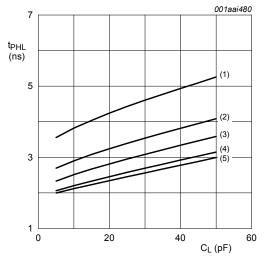


c. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)} = 1.5 V$ 

(1)  $V_{CC(B)} = 1.2 V.$ (2)  $V_{CC(B)} = 1.5 V.$ (3)  $V_{CC(B)} = 1.8$  V. (4) V<sub>CC(B)</sub> = 2.5 V. (5) V<sub>CC(B)</sub> = 3.3 V.



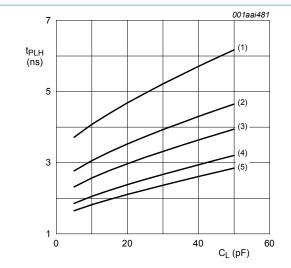
b. HIGH to LOW propagation delay (nAn to nBn); V<sub>CC(A)</sub> = 1.2 V



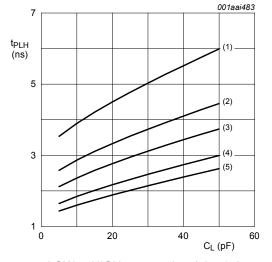
d. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)} = 1.5 V$ 

Fig. 8. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C

#### 16-bit dual supply translating transceiver with configurable voltage translation; 3-state



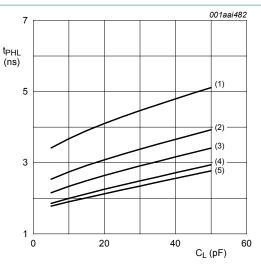
a. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)}$  = 1.8 V



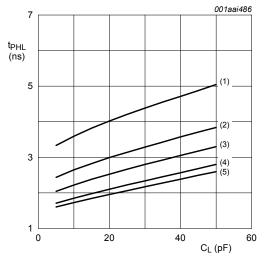
c. LOW to HIGH propagation delay (nAn to nBn);  $V_{CC(A)}$  = 2.5 V



Fig. 9. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C

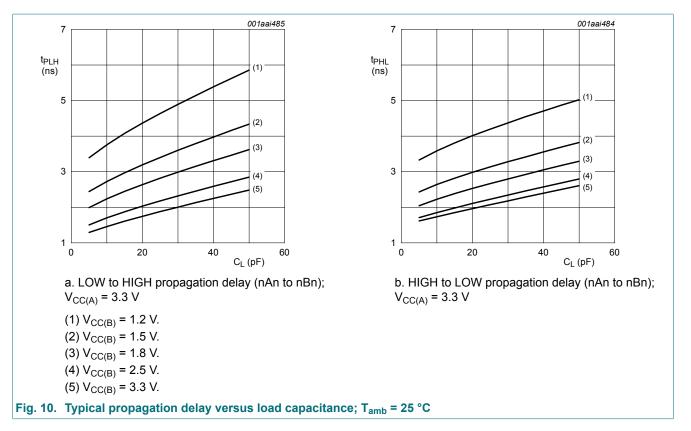


b. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)}$  = 1.8 V



d. HIGH to LOW propagation delay (nAn to nBn);  $V_{CC(A)}$  = 2.5 V

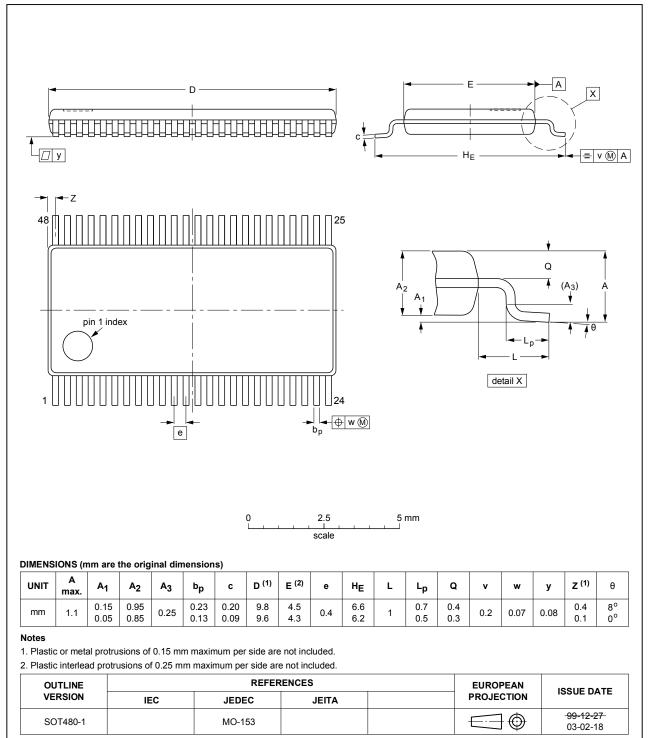
#### 16-bit dual supply translating transceiver with configurable voltage translation; 3-state



### 12. Package outline

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 4.4 mm; lead pitch 0.4 mm





#### Fig. 11. Package outline SOT480-1 (TSSOP48)

### 13. Abbreviations

Table 16. Abbreviations						
Acronym	Description					
DUT	Device Under Test					
ESD	ElectroStatic Discharge					
НВМ	Human Body Model					
MIL	Military					
MM	Machine Model					

### 14. Revision history

#### Table 17. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74AVC16T245_Q100 v.2	20190114	Product data sheet	-	74AVC16T245_Q100 v.1			
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guideline of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
74AVC16T245_Q100 v.1	20131028	Product data sheet	-	-			

### 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

#### **Definitions**

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### **Disclaimers**

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

**Right to make changes** — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications — This Nexperia product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or

equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <u>http://www.nexperia.com/profile/terms</u>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

#### Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.